


INFORMATION DISCLOSURE CITATION <small>(Use several sheets if necessary)</small>				Docket Number (Optional) KS-4316US		Application Number 10/608,922	
<div style="position: relative; height: 100px;"> <div style="position: absolute; top: 0; left: 0; width: 100%; height: 100%; background: repeating-linear-gradient(45deg, transparent, transparent 2px, black 2px, black 4px); border: 1px solid black; border-radius: 50%; transform: rotate(45deg); opacity: 0.5; pointer-events: none;"></div> <div style="position: absolute; top: 10%; left: 10%; font-weight: bold; font-size: 1.2em;"> SEP 17 2003 </div> </div>				Applicant(s) Kragl, Hans		Group Art Unit 2874 Not Yet Known	
				Filing Date June 27, 2003			
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<i>Aullah</i> <div style="border-left: 1px solid black; height: 100px; margin-left: 5px;"></div>		6,504,107	1/7/03	Hans Kragl			
		6,004,046	12/21/99	Sosaku Sawada			
		4,945,400	7/31/90	Greg E. Blonder et al.			
		5,987,202	11/16/99	Werner Gruenwald et al.			
		5,434,939	7/18/95	Kenichi Matsuda			
		5,349,234	9/20/94	William F. Desjardin et al.			
		5,737,467	4/7/98	Takeshi Kato et al.			
		5,660,461	8/26/97	Ronald W. Ignatius et al.			
		6,070,315	6/6/00	Klaus Schubert et al.			
		5,675,678	10/7/97	Wolfgang Neuberger et al.			
	5,028,110	7/2/91	William T. Plummer				
FOREIGN PATENT DOCUMENTS							
REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO
<i>Aullah</i> <div style="border-left: 1px solid black; height: 100px; margin-left: 5px;"></div>		DE 38 24 395 C2	11/16/89	Germany			✓
		DE 33 39 189 A1	5/9/85	Germany			✓
		DE 198 52 832 A	5/25/00	Germany			✓
		WO 98/26885	6/25/98	PCT		✓	
		DE 198 51 265 A	5/18/00	Germany			✓
OTHER DOCUMENTS <small>(Including Author, Title, Date, Pertinent Pages, Etc.)</small>							
<i>Aullah</i> <div style="border-left: 1px solid black; height: 100px; margin-left: 5px;"></div>		Kragl, H. et al., "Microstructured three-dimensional printed circuit boards: a novel fabrication technology for optical transceiver modules," Proceedings, MICROtec 2000; VDE World Microtechnologies Congress; Vol. 1, pp. 107-110. (No date)					
		Kragl, H. et al.; MICROMID: A low cost fabrication technology for polymer fiber transceiver modules. POE Conference 2000, Boston, U.S.A.					
EXAMINER Ak m E ullah				DATE CONSIDERED Dec. 08/2003			
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

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U.S. PATENT DOCUMENTS									
*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE		
Adlab		5,795,519	8/18/98	Walter Bacher et al.					
		5,645,977	7/8/97	Tung-Chuan Wu et al.					
		5,993,075	11/30/99	Kai-Feng Huang et al.					
		4,647,331	3/3/87	Daniel N. Koury et al.					
		2001007526 A1	7/12/01	Masaya Ohkohdo et al.					
FOREIGN PATENT DOCUMENTS									
Adlab	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation		
		DE 196 02 079 C1	5/15/97	Germany			YES	NO	
		DE 195 42 658 A1	5/22/97	Germany				✓	
		WO 00/28362	5/18/00	PCT				✓	
		WO 96/22177	7/25/96	PCT				✓	
	0 611 975 A1	2/22/89	Europe			✓			
OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)									
EXAMINER Akron Enayetullah				DATE CONSIDERED 12/8/03					

